

## **MOSFET**

## **Small-Signal Transistor**

#### **Features**

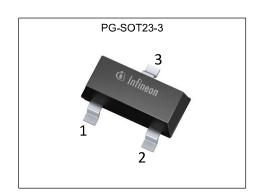
- n-channel
- enhancement mode
- Logic level (4.5V rated)
- dv/dt rated
- 100%lead-free; RoHS compliant
- Halogen-free according to IEC61249-2-21

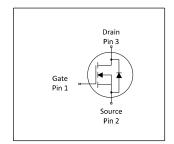
### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

**Table 1** Key Performance Parameters

Parameter	Value	Unit
V <sub>DS</sub>	600	V
R <sub>DS(on),max</sub>	500	Ω
I <sub>D</sub>	0.021	A
ESD Sensitivity, JESD22-A114 (HBM)	Class 0 (<250V)	











Type / Ordering Code	Package	Marking	Related Links
BSS127I	PG-SOT23	lls	-

# Small-Signal Transistor BSS127I



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## **Small-Signal Transistor** BSS127I



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

D	C Is a l		Values	5	11!4	N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I <sub>D</sub>	-	-	0.021 0.017	А	T <sub>A</sub> =25 °C T <sub>A</sub> =70 °C
Pulsed drain current	I <sub>D,pulse</sub>	-	-	0.09	Α	<i>T</i> <sub>A</sub> =25 °C
Reverse diode dv/dt	d <i>v</i> /d <i>t</i>	-	-	6	kV/µs	/ <sub>D</sub> =0.021 A, V <sub>DS</sub> =480 V, di/dt=200 A/μs, T <sub>j,max</sub> =150 °C
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	0.50	W	T <sub>A</sub> =25 °C
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### Thermal characteristics 2

#### Table 3 Thermal characteristics

Davamatav	Symphol	Values			I Imia	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - minimal footprint	$R_{thJA}$	-	-	250	K/W	-

## **Electrical characteristics**

at  $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	600	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =250 μA
Gate threshold voltage	$V_{\rm GS(th)}$	1.4	2.0	2.6	V	$V_{DS}=V_{GS}$ , $I_{D}=8 \mu A$
Drain-source leakage current	I <sub>D (off)</sub>	-	-	0.1 10	μA	V <sub>DS</sub> =600 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =600 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	330 310	600 500	Ω	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =0.016 A V <sub>GS</sub> =10 V, I <sub>D</sub> =0.016 A
Transconductance	$g_{fs}$	0.007	0.015	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =0.01 A

# Small-Signal Transistor BSS127I



Table 5 Dynamic characteristics

Parameter	Councile of	Values				N 4 4 7 4 8 199
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C <sub>iss</sub>	-	21	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =25 V, f=1 MHz
Output capacitance	Coss	-	2.4	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =25 V, f=1 MHz
Reverse transfer capacitance	C <sub>rss</sub>	-	1.0	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =25 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	6.1	-	ns	$V_{\rm DD} = 300 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 0.01 \text{ A}, \ R_{\rm G,exi} = 6 \ \Omega$
Rise time	t <sub>r</sub>	-	9.7	-	ns	$V_{\rm DD} = 300 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 0.01 \text{ A}, \ R_{\rm G,ext} = 6 \ \Omega$
Turn-off delay time	$t_{ m d(off)}$	-	14	-	ns	$V_{\rm DD} = 300 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 0.01 \text{ A}, \ R_{\rm G,ext} = 6 \ \Omega$
Fall time	t <sub>f</sub>	-	115	-	ns	$V_{\rm DD} = 300 \text{ V}, \ V_{\rm GS} = 10 \text{ V}, \ I_{\rm D} = 0.01 \text{ A}, \ R_{\rm G,ext} = 6 \ \Omega$

Table 6 Gate charge characteristics

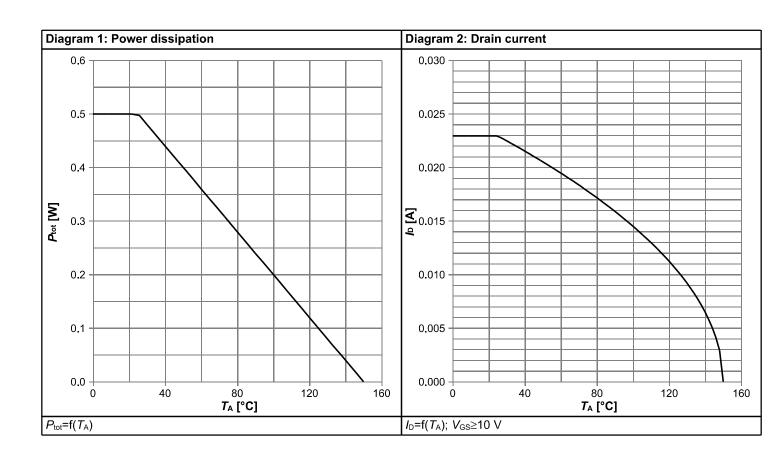
Parameter	Cymphal	Values			Unit	Note / Took Consisting
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	0.07	-	nC	$V_{DD}$ =300 V, $I_{D}$ =0.01 A, $V_{GS}$ =0 to 10 V
Gate to drain charge	$Q_{gd}$	-	0.31	-	nC	$V_{\rm DD}$ =300 V, $I_{\rm D}$ =0.01 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total	Qg	-	0.65	-	nC	$V_{\rm DD}$ =300 V, $I_{\rm D}$ =0.01 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	3.56	-	V	$V_{DD}$ =300 V, $I_{D}$ =0.01 A, $V_{GS}$ =0 to 10 V

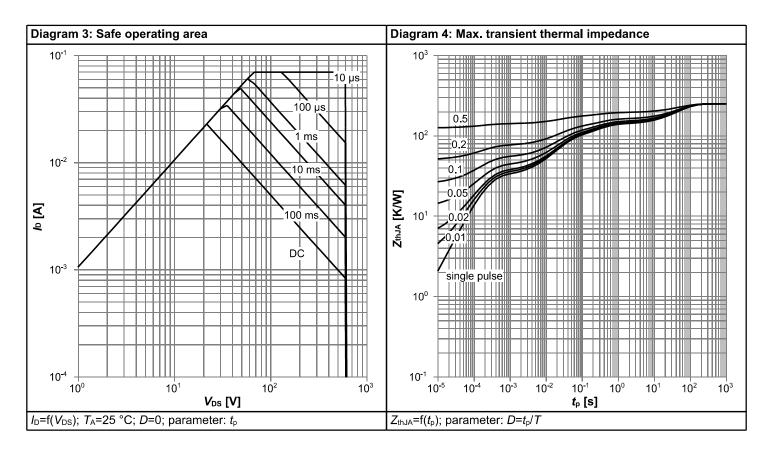
### Table 7 Reverse diode

Parameter	Symphol		Values			Nata / Tank Oam diking
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	I <sub>S</sub>	-	-	0.016	Α	T <sub>A</sub> =25 °C
Diode pulse current	<b>I</b> S,pulse	-	-	0.09	Α	T <sub>A</sub> =25 °C
Diode forward voltage	$V_{ extsf{SD}}$	-	0.82	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =0.016 A, T <sub>j</sub> =25 °C
Reverse recovery time	$t_{rr}$	-	160	240	ns	V <sub>R</sub> =300 V, I <sub>F</sub> =0.016 A, di <sub>F</sub> /dt=100 A/µs
Reverse recovery charge	Q <sub>rr</sub>	-	13.2	19.8	nC	V <sub>R</sub> =300 V, I <sub>F</sub> =0.016 A, di <sub>F</sub> /dt=100 A/μs

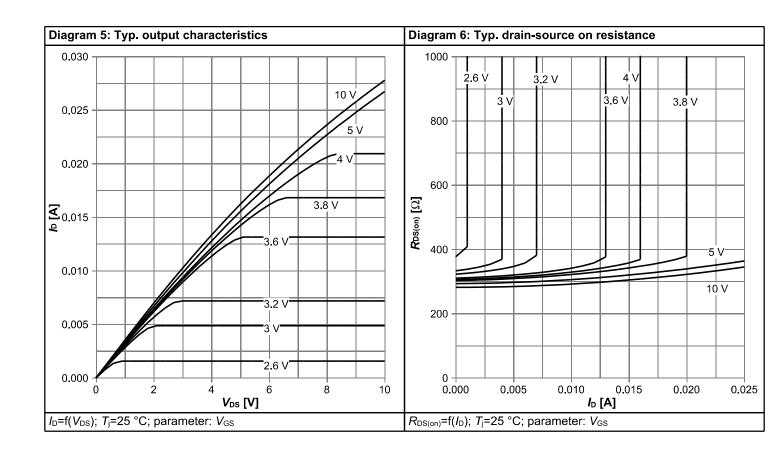


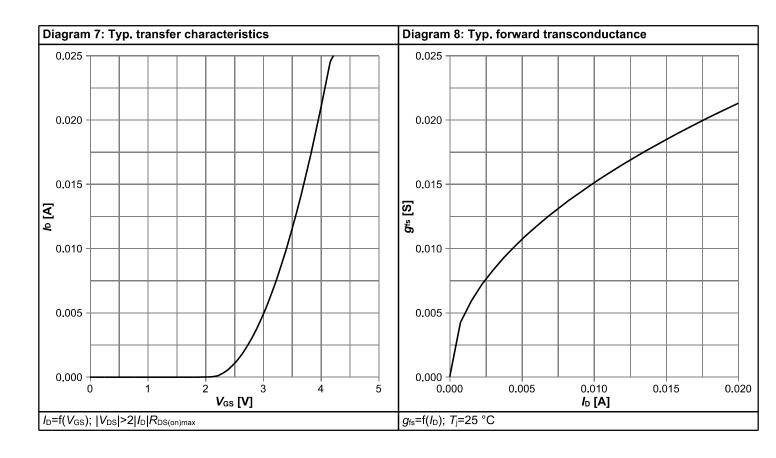
## 4 Electrical characteristics diagrams



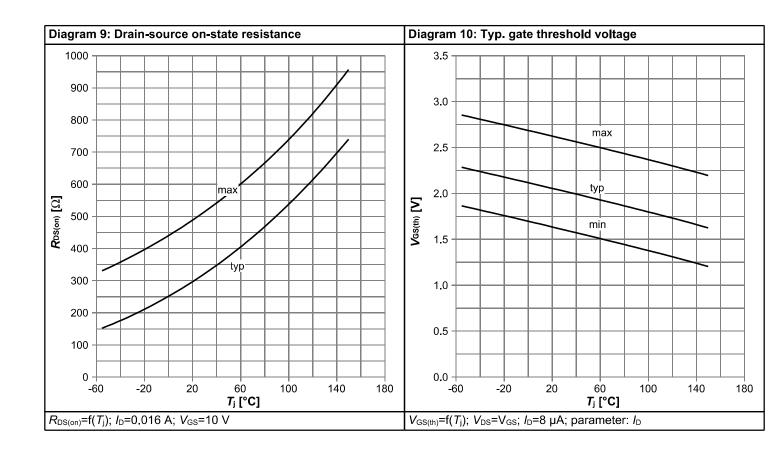


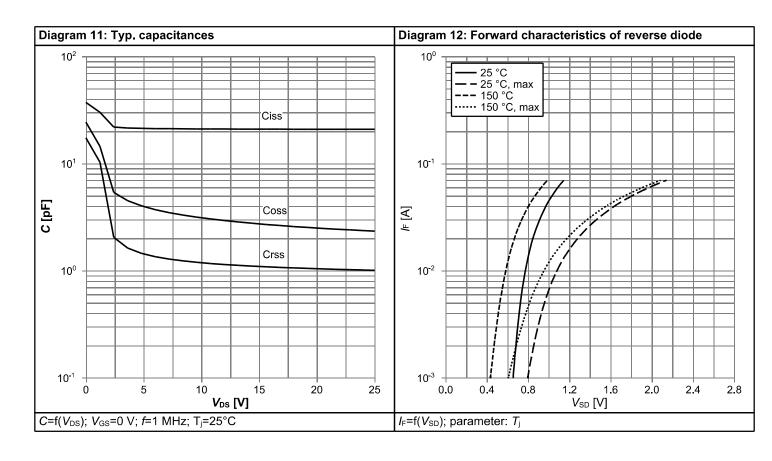




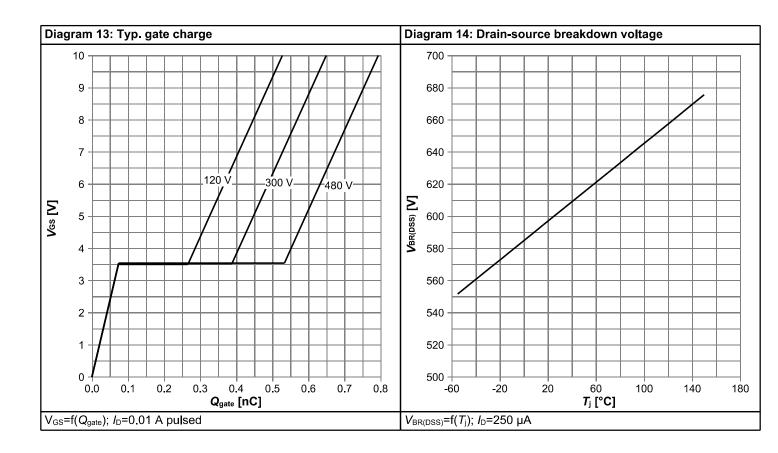


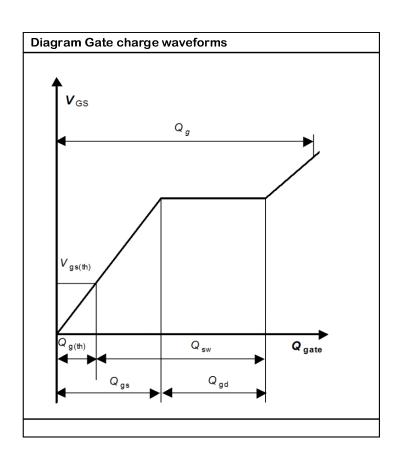






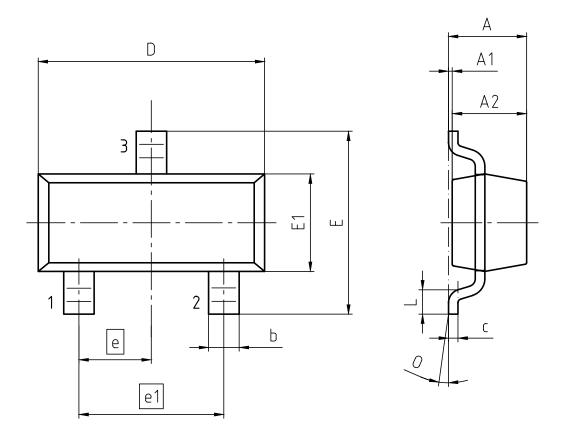








## 5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-SOT	PG-SOT23-3-U01				
REVISION: 01	DATE: (	09.12.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
Α	0.89	1.12				
A1	0.01	0.10				
A2	0.88	1.02				
b	0.30	0.50				
С	80.0	0.20				
D	2.80	3.04				
E	2.10	2.64				
E1	1.20	1.40				
е	0.	0.95				
e1	1.90					
L	0.15 0.60					
0	0°	8°				

Figure 1 Outline PG-SOT23, dimensions in mm

## Small-Signal Transistor BSS127I



### **Revision History**

BSS127I

Revision: 2021-03-17, Rev. 2.1

Previous Revision

1 10110401	Toviodo (toviolo)						
Revision	vision Date Subjects (major changes since last revision)						
2.0	2021-01-25	Release of final version					
2.1	2021-03-17	Update technology naming					

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